

Product Change Notification

Change Notification #: 117341 - 00

Change Title: Intel® Server Chassis H2224XXLR3,

PCN 117341-00, Label, Update location placement of data printed on the Package Regulatory Label & Removing Vietnam

(ICT) Logo

Date of Publication: December 13, 2019

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:

December 13, 2019

Description of Change to the Customer:

Intel is updating the Package Regulatory Label for Intel Server Chassis by rearranging the location of data printed on the label and removing the Vietnam (ICT) Logo at the same time:

Common:



Package:



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^{*} Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

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Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation.

Please see your Intel representative for any questions or concerns.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
H2224XXLR3	948907	J57870-006	J57870-007

PCN Revision History:

Date of Revision: Revision Number: Reason:

December 13, 2019 00 Originally Published PCN

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com
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Japan Email: jccb.ijkk@intel.com

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